MSKSEMI 美森科













ESD

TVS

TSS

MOV

GDT

PLED

AMS1117-XXX

Product specification





概述

AMS1117 是一款低压差的线性稳压器。

特点

- 包括三端可调输出和固定电压输出版本(固定电压包括 1.2V, 1.8V, 2.5V, 3.3V, 5V等, 其他电压规格可根据用户定制)
- 最大输出电流为 1A
- 输出电压精度高达±2%
- 稳定工作电压范围为高达 12V
- 电压线性度为 0.2%
- 负载线性度为 0.4%
- 环境温度: TA 的范围是 0℃~125℃

用途

- 计算机主板、显卡
- LCD 监视器及 LCD TV
- DVD 解码板
- ADSL 等设备
- 开关电源的后级稳压

封装形式和管脚定义功能

封装	引脚排列图	管体标记
SOT-223	1 2 3	AMS1117 3.3**** 备注: 3.3 代表固定电压, ****代表内部生产订单编号

引脚定义

引脚号	符号	定义
1	GND	接地脚
2	Vout	输出端
3	Vin	输入端

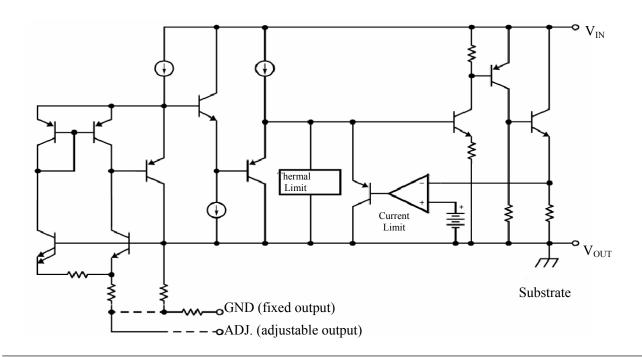
固定电 压型

引脚号	符号	定义
1	Adj.	可调端
2	Vout	输出端
3	Vin	输入端

可调电 压型



功能图



极限值

参数名称	符号	数值	单位
最大输入电压	Vin	18	V
最大节温	TJ	125	°C
最大环境温度	TA	125	°C
贮存温度	Ts	-65~ +150	°C
焊接温度和时间		260°C,10S	

推荐工作条件

名称	最小	推荐	最大	单位
输入电压范围			15	V
工作环境温度	0		125	°C



主要参数和工作特性

Tj=25℃

参数	参数说明	条件	最小值	典型值	最大值	单位
Vref	参考电压	lout=10mA, Vin-Vout=2V 10mA≤lout≤1A ,1.5V≤Vin-Vout≤10V	1.225	1.25	1.275	V
		AMS1117-1.50V 10mA≤lout≤1A ,3.0V≤Vin≤10V	1.470	1.5	1.530	٧
Vout	输出电压	AMS1117-1.80V 10mA≤lout≤1A ,3.25 V≤Vin≤10V	1.764	1.80	1.836	V
		AMS1117-2.50V 10mA≤lout≤1A ,3.9 V≤Vin≤10V	2.45	2.50	2.55	V
		AMS1117-3.3V 10mA≤lout≤1A , 5.3 V≤Vin≤12V	3.235	3.3	3.365	٧
		AMS1117-5V 10mA≪lout≪1A , 6.5V≪Vin≪12V	4.9	5	5.1	V
		AMS1117-ADJ lout=10mA, V≪Vin-Vout≪10V		5	18	mV
		AMS1117-1.5V lout=10mA, 2.75V≪Vin≪10V		5	18	mV
ΔVout	电压线性度	AMS1117-1.8V lout=10mA, 3.25 V≪Vin≪10V		5	18	mV
		AMS1117-2.50V lout=10mA, 3.9 V≤Vin≤10V		5	18	mV
		AMS1117-3.3V lout=10mA, 5.3 V≤Vin≤12V		9	18	mV
		AMS1117-5V lout=10mA,6.5V≤Vin≤12V		9	18	mV
ΔVout	负载线性度	AMS1117-ADJ Vin = 3.25V, 10mA≤lout≤1A		9	18	mV
17000	火热线压灰	AMS1117-1.5V Vin = 3.25V, 10mA≤lout≤1A		9	18	mV

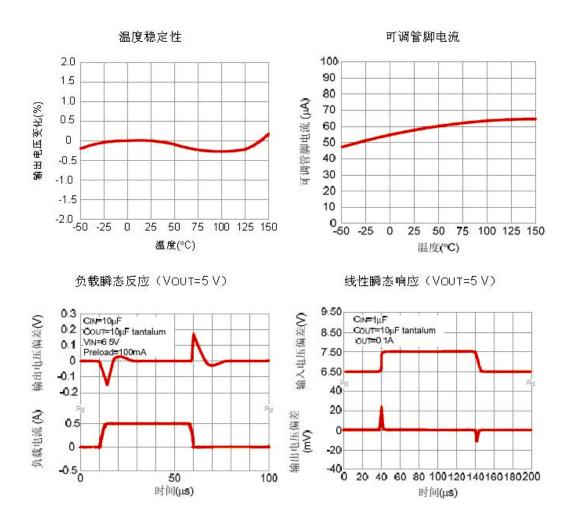


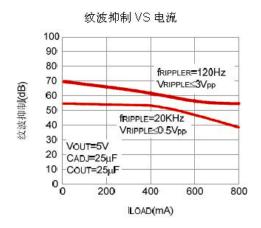
主要参数和工作特性

		AMS1117-1.8V Vin = 3.25V, 10mA≤lout≤1A	10	18	mV
		AMS1117-2.5V Vin=4.5 V, 10mA≤lout≤1A	10	18	mV
	_	AMS1117-3.3V Vin=5.3V, 0≤lout≤1A	12	20	mV
		AMS1117-5V Vin=6.5V, 0≪lout≪1A	12	20	mV
Vin-Vout	最小输入输出 电压差	ΔVout, ΔVref,=1%, lout=1A		1.4	٧
llimit	最小负载电流	AMS1117-ADJ		10	mA
		AMS1117-ADJ Vin=4.0V		12	mA
		AMS1117-1.5V,Vin=4.8V		12	mA
Iq	静态电流	AMS1117-1.8V,Vin=4.8V		12	mA
iq		AMS1117-2.5V,Vin=4.8V	 	12	mA
		AMS1117-3.3V,Vin=4.8V		12	mA
		AMS1117-5.0V,Vin=4.8V		12	mA



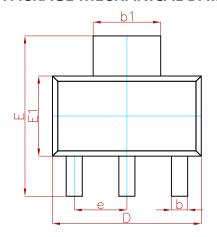
典型電性特性曲綫

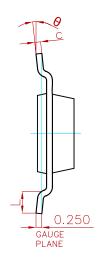


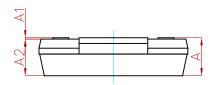




PACKAGE MECHANICAL DATA

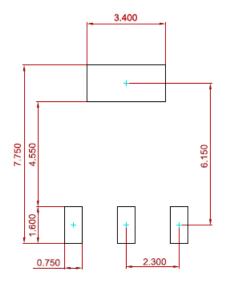






Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Cyllibol	Min.	Max.	Min.	Max.	
Α		1.800		0.071	
A1	0.020	0.100	0.001	0.004	
A2	1.500	1.700	0.059	0.067	
b	0.660	0.840	0.026	0.033	
b1	2.900	3.100	0.114	0.122	
С	0.230	0.350	0.009	0.014	
D	6.300	6.700	0.248	0.264	
E	6.700	7.300	0.264	0.287	
E1	3.300	3.700	0.130	0.146	
е	2.300(BSC)		0.091	(BSC)	
L	0.750		0.030		
θ	0°	10°	0°	10°	

Suggested Pad Layout



Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.050mm.
- 3. The pad layout is for reference purposes only.

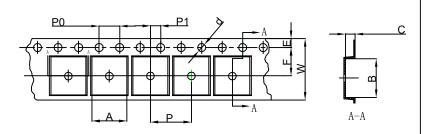
REEL SPECIFICATION

P/N PKG		QTY
AMS1117-XXX	SOT-223	2500



SOT-223 Tape and Reel

SOT-223 Embossed Carrier Tape

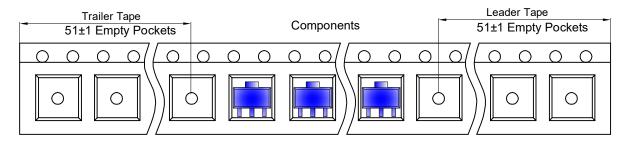


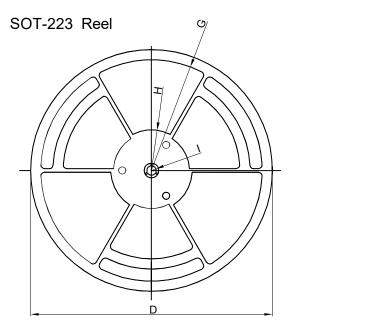
Packaging Description:

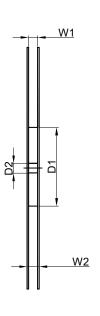
SOT-223 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 2,500 units per 13" or 33.0cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type A B C d E F P0 P P1 W							W			
SOT-223	6.765	7.335	1.88	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

SOT-223 Tape Leader and Trailer







Dimensions are in millimeter								
Reel Option	D	D1	D2	G	Н	I	W1	W2
13"Dia	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60



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